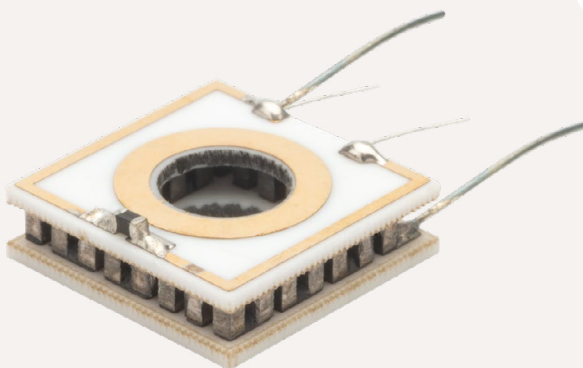
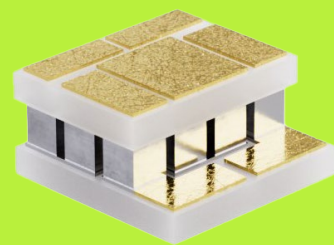


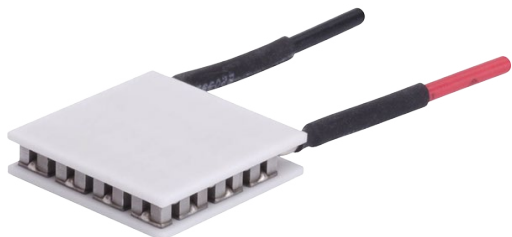
Product Catalog

Thermoelectric Cooler Options



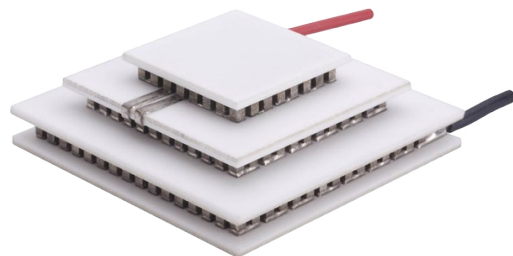
Tark Thermal Solutions offers solid-state thermoelectric coolers with a wide range of cooling capacities, temperature differentials, form factors, finishing options and thermal cycling capabilities. Select from our standard thermoelectric cooler products or engage with a Laird Thermal expert to quickly develop a custom thermoelectric cooling solution with our thermoelectric coolers prototyping center for the optimum thermal management solution.

Form Factor



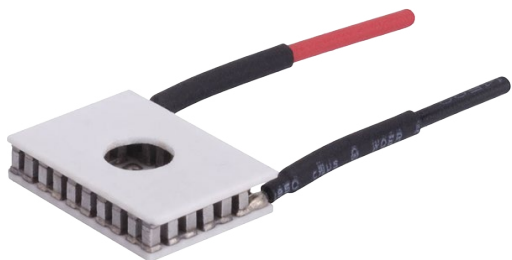
Single Stage Thermoelectric Coolers

- Standard form factor



Multistage Thermoelectric Cooler

- Achieves higher temperature differential than single stage thermoelectric coolers



Thermoelectric Cooler with holes

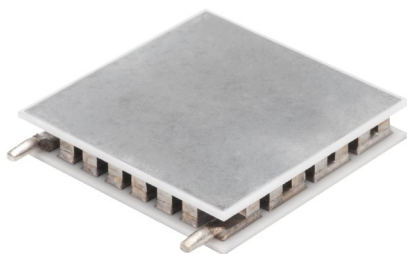
- Central hole accommodates light protrusion for optics, mechanical fastening or temperature probe



Custom Shape Thermoelectric Cooler

- Modification of module to meet specific application requirements

Finish



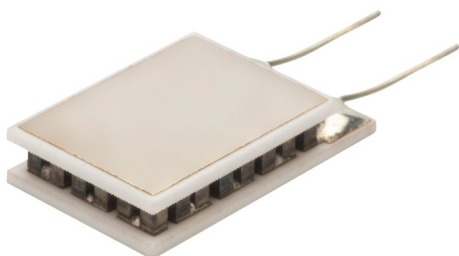
Metallized Surface

- Allows for soldering the thermoelectric cooler directly to mating surfaces without using interface materials that can outgas.
- More cost-effective than gold plating



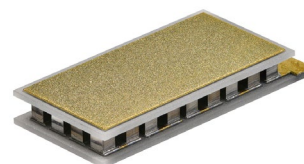
Lapped (Non-Metallized Surface)

- Used for thermoelectric cooler arrays
- Thermal interface material required during assembly
- Thickness tolerance options:
 - +/- 0.001" (0.025 mm)
 - +/- 0.0005" (0.013 mm)



Pre-Tinning

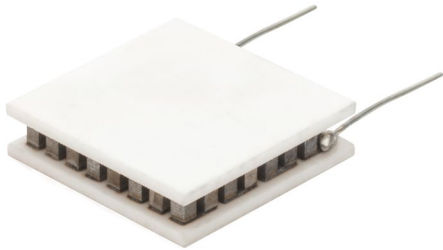
- Simplifies the solder reflow process.
- InSn Solder (118°C) used for standard thermoelectric coolers
BiSn solder (138°C) used for high temperature thermoelectric coolers



Gold (Au) Plating

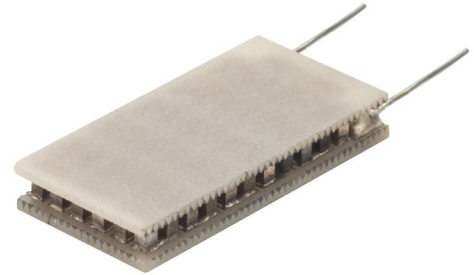
- Allows for soldering the thermoelectric cooler directly to mating surfaces without using interface materials that can outgas.
- Gold provides greater adhesion than metallized surfaces

Ceramic Substrate



96% Aluminum Oxide (ALO)

- More cost-effective than aluminum nitride
- Thermal conductivity: 25-35 W/(m.K) and 170-230 W/(m.K)



Aluminum Nitride (ALN)

- Better thermal conductivity (10 times better performance) than aluminum oxide (ALO)

Sealant



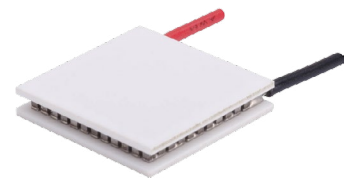
RTV (Translucent or White)

- Non-corrosive, silicone adhesive sealant
- For applications operating below dew point or where rapid changes between hot and cold occur, for example thermal cycling
- Automation of RTV sealant is more cost effective



Epoxy (Black)

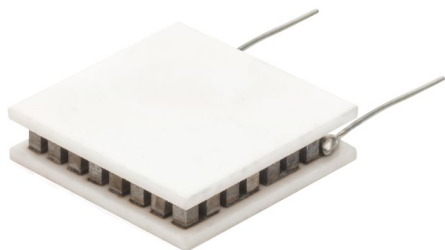
- Low density syntactic foam epoxy encapsulant
- For applications operating below dew point
- Better thermal insulation barrier than RTV sealant



Conformal Coating

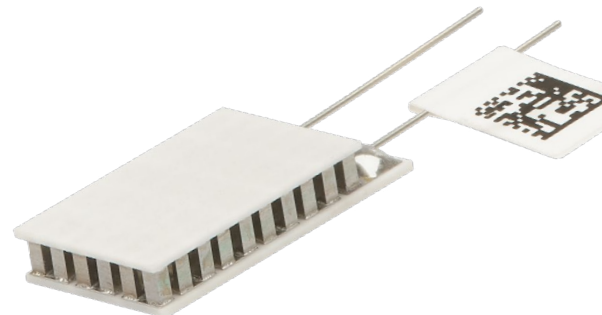
- Transparent general purpose micron thickness surface coating barrier than RTV sealant
- Can be used in conjunction with RTV or Epoxy
- Usable temp range -55 to 150 C

Wire



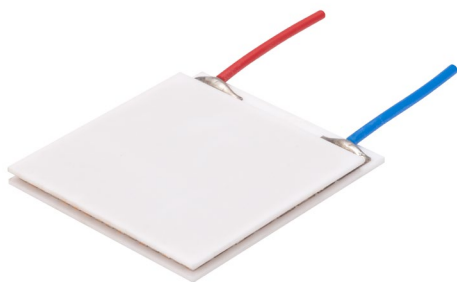
PVC Insulated wire

- Standard for all thermoelectric coolers except HiTemp ETX Series



Un-insulated wire

- Used for applications that are sensitive to outgassing



Teflon Wire

- For high temperature thermoelectric coolers (HiTemp ETX Series)



Optional Lead Length

- Standard and non-standard lead lengths available to accommodate application space constraints
- Standard lead-lengths: 2.25", 4.5", 6" depending on product series
- Alternate lead lengths range from 2.25" to 24"

Other



TEC Array or Connector

- We can assemble array to reduce customer workload.



Integrate Thermistors with TEC

- Space saving for customer application
- Allows for closed-loop feedback control



Advanced Patterns

- Allows for small electronics to be mounted on the thermoelectric cooler and eliminates additional ceramic layers



Porch style option

- Front porch or wings
- Allows for accommodating different lead attachment configurations



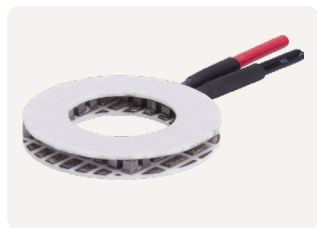
Wire Bonding Post

- Allows for wire bonding to application

Segmentation of ceramic

- Reduces mechanical stresses to the thermoelectric cooler in thermal cycling application

Custom Thermoelectric Coolers



Our wide range of sealing and finishing options offer additional configurable flexibility that can provide optimized fit to your application. All thermoelectric coolers are made with high-grade ceramics and semiconductor materials, resulting in Best-in-Class quality performance products. In this table you find the options available for our all our product series. Consult with Laird Thermal Systems on customized thermoelectric cooler solutions Minimum order quantity applies.

SURFACE FINISH OPTIONS	CP	OPTO-TEC™ OTX/HTX	HITEMP ETX	POWER CYCLING PCX	ULTRATEC™ UTX	MULTISTAGE	ANNULAR SH/RH
Metallized Hot/Cold Surface	MM	00	-	-	00	00	MM
Non-Metallized Hot and/or Cold face	L	11	11	11	11	11	L
Pre-tinning Hot and/or Cold face with 118°C InSn Solder	TT	22	-	-	22	22	TT
Pre-tinning Hot and/or Cold face with 138°C BiSn Solder	-	33	-	-	-	-	-
Au plating (Hot/Cold Surface)	-	GG	-	-	GG	-	-

Example: CP10-127-05TL = Pre-tinned Hot Face (118°C InSn), Non-Metallized Cold Face. Note: Metallization and pretinning are not recommended for module sizes larger than 12 x 12 mm's. Consult datasheet for module thicknesses for each surface finishing option. Contact Laird Thermal Systems for finishing options for Multistage Modules.

THICKNESS TOLERANCE OPTIONS	CP	OPTO-TEC™ OTX/HTX	HITEMP ETX	POWER CYCLING PCX	ULTRATEC™ UTX	MULTISTAGE	ANNULAR SH/RH
+/- 0.001" (0.025 mm)	L1	TA	TA	TA	TA	-	TA
+/- 0.0005" (0.013 mm)	L2	TB	TB	TB	TB	-	TB

Example: CP10-127-05-L2 = thickness is 3.2 mm +/- 0.013 mm. Contact Laird Thermal Systems for thickness options for Multistage Modules.

MOISTURE PROTECTION OPTIONS	CP	OPTO-TEC™ OTX/HTX	HITEMP ETX	POWER CYCLING PCX	ULTRATEC™ UTX	MULTISTAGE	ANNULAR SH/RH
RTV perimeter seal, Color: Translucent or White	RT	RT	RT	RT	RT	RT	RT
Epoxy perimeter seal, Color: Black	EP	EP	EP	EP	EP	EP	EP
Conformal Coating	EC	EC	EC	EC	EC	EC	EC

Example: CP10-127-05-L2-RT = RTV silicone perimeter seal Silicone (RTV) is an all purpose sealant that exhibits good sealing characteristics and retains its elastomeric properties over a wide temperature range, -60 to 200°C. The sealant is non-corrosive to many chemicals and exhibits good electrical properties with low thermal conductivity. Epoxy (EP) is an effective barrier to moisture that exhibits a useable temperature range of -40 to 130°C. When cured the material is completely uni-cellular and therefore the moisture absorption is negligible. The material exhibits a low dielectric constant, low coefficient of thermal expansion and low shrinkage.

WIRE OPTIONS	CP	OPTO-TEC™ OTX/HTX	HITEMP ETX	POWER CYCLING PCX	ULTRATEC™ UTX	MULTISTAGE	ANNULAR SH/RH
Custom lead length # in inches,	RT	RT	RT	RT	RT	RT	RT

Example: CP10-127-05-L2-W8 = Wire length is 8" (203 mm). Reference datasheet for standard lead length, wire type and insulation sleeving. Consult with Laird Thermal Systems for wire bondable posts or thru hole mount.



TTS-CAT-THERMOELECTRIC-COOLER-OPTIONS

Any information furnished by Tark Thermal Solutions and its agents, whether in specifications, data sheets, product catalogues or otherwise, is believed to be (but is not warranted as being) accurate and reliable, is provided for information only and does not form part of any contract with Tark Thermal Solutions. All specifications are subject to change without notice. Tark Thermal Solutions assumes no responsibility and disclaims all liability for losses or damages resulting from use of or reliance on this information. All Tark Thermal Solutions products are sold subject to the Tark Thermal Solutions Terms and Conditions of sale (including Tark Thermal Solutions' limited warranty) in effect from time to time, a copy of which will be furnished upon request.

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